**Material Set Change:**

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| --- | --- | --- | --- |
|  | |  |  |
| Package Material Set | | Carsem | ASE Chungli |
| MSOP | Die Attach | Ablestik 84-1 LMISR4 | Hitachi EN4900 |
| Mold Compound | Sumitomo 6600H | Sumitomo G700 |
| Wire | 0.8mil, 1.0mil and 1.2/1.3 mil Gold wire | 0.8mil, 1mil and 1.2/1.3mil Gold Wire |